

VSC8541

Single Port Gigabit Ethernet Copper PHY with GMII/RGMII/MII/RMII Interfaces

Low-power, small form-factor Cu PHY with IEEE 802.3az Energy Efficient Ethernet (EEE), Wake-on-LAN (WoL), Synchronous Ethernet (SyncE), Start of Frame (SOF), and Fast Link Failure 2.0 (FLF2) indication, with widest I/O LVCMOS support.

The VSC8541 device, offered in a small 8 mm x 8 mm single-row QFN package, is designed for space-constrained 10/100/1000BASE-T applications. It features integrated line-side termination to conserve board space, lower EMI, and improve system performance. Additionally, integrated RGMII version 2.0 standard timing compliant compensation eliminates the need for on-board delay lines.

The device supports the industry's widest range of LVCMOS levels for a parallel MAC interface including: 1.5 V, 1.8 V, 2.5 V, and 3.3 V, as well as 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V support on the MDIO/MDC interface. It includes Microsemi's EcoEthernet™ 2.0 technology with Energy Efficient Ethernet and power saving features to reduce power based on link state and cable reach. It optimizes power consumption at all link operating speeds, and features Wake-on-LAN power management using magic packets.

The device has a recovered clock output for Synchronous Ethernet applications. Programmable clock squelch control is included to inhibit undesirable clocks from propagating and to help prevent timing loops. Microsemi's patented Ring Resiliency™ allows a PHY port to switch between master and slave timing references with no link drop while in 1000BASE-T mode.

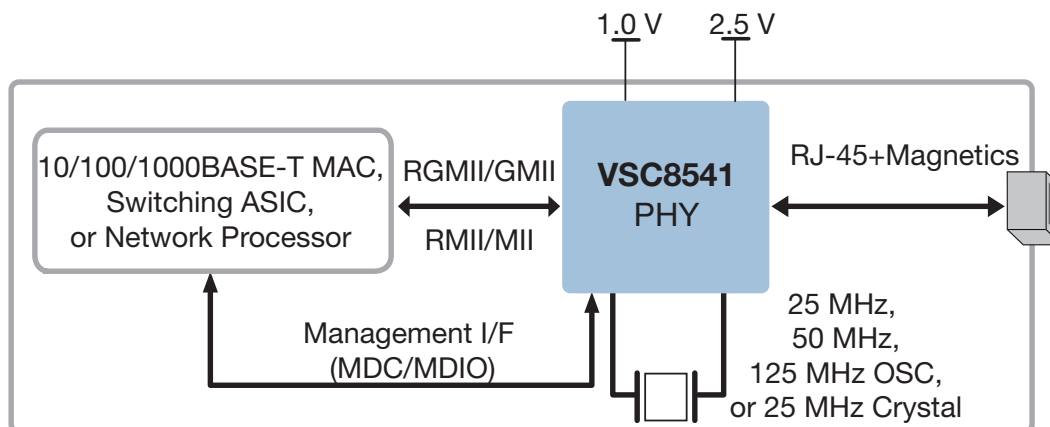
VSC8541 also includes Fast Link Failure (FLF) indication for high-availability networks. FLF indication identifies the onset of a link failure in less than 1 ms typical, which goes beyond the IEEE 802.3 standard requirement of 750 ms ±10 ms (link master). In addition, the device adds a programmable threshold for applications where indication of even a potential link drop must be known at the microsecond level (<10 μs).

Highlights

- EcoEthernet™ 2.0, with Energy Efficient Ethernet
- Fast Link Failure™ 2.0 with failure indication for commutator ring applications
- Widest voltage range, fully-compliant parallel MAC interface device
- Start of Frame sync for ingress and egress enables high accuracy calculation of latency (RGMII/RMII mode, VSC8541-03 only)
- Configurable drive strength on MAC interface enables better control of system-level EMI/EMC
- Synchronous Ethernet support and Ring Resiliency™

Applications

- IoT applications such as digital signage, eHealth, and industrial grade switches for automation
- Consumer electronics such as CPE, UHD TV, media servers, and NAS
- Wireless backhaul, Hybrid Wi-Fi / LTE-U APs, 4G/5G Small Cells



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Superior PHY and Interface Technology

- 10/100/1000BASE-T Ethernet copper transceiver (IEEE 802.3ab compliant) with Microsemi exclusive non-TDR based VeriPHY™ cable diagnostics software enables testing without taking down link or impacting data bandwidth while in 1000BASE-T mode
- Patented line driver with low-EMI voltage mode and integrated line-side termination resistors
- WOL support using magic packets
- HP Auto-MDIX and manual MDI/MDIX support
- RGMII/GMII/RMII/MII MAC interface with widest voltage range support in the industry: 1.5 V, 1.8 V, 2.5 V, and 3.3 V (LVCMOS)
- Jumbo frame support up to 16 kilobytes with programmable synchronization FIFOs
- Additional internal FIFO located on ingress side enables support for EtherCAT® applications

Synchronous Ethernet Support

- Recovered clock output with programmable clock squelch control and FLF indication (<1 ms typical) for ITU-T G.8261/Y.1361 compliant SyncE applications
- 1000BASE-T Ring Resiliency™ to switch between master and slave timing without dropping link
- Clock output squelch to inhibit clocks during auto-negotiation and no link status

1588v2 PTP System-Level Support (VSC8541-03 only)

- When in RGMII mode, SOF signal (for both ingress and egress) on line side along with synchronized 125 MHz clock enables a high-accuracy time stamping capability when used in conjunction with an appropriate 1588v2 time stamping engine

Best-in-Class Power Consumption

- EcoEthernet™ 2.0 green energy efficiency with ActiPHY™, PerfectReach™, and IEEE 802.3az EEE
- Clause 45 registers to support IEEE 802.3az EEE and IEEE 802.3bf
- Fully optimized power consumption for all link speeds
- 10BASE-Te mode support enables even lower power consumption than 10BASE-T

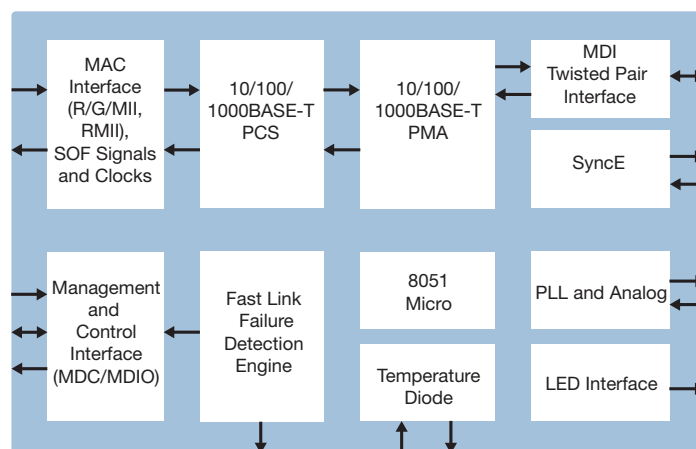
Key Specifications

- Compliant with IEEE 802.3 (10BASE-T, 10BASE-Te, 100BASE-TX, 1000BASE-T)
- Supports GMII and RGMII (version 1.3), RMII (version 1.2), and MII at 1.5 V, 1.8 V, 2.5 V, and 3.3 V LVCMOS
- RGMII version 2.0 timing compliant
- Supports clocking from 25 MHz crystal or 25/50/125 MHz oscillator
- Microcontroller-free configurability through hardware strapping
- Optionally reports if a link partner is requesting inline Power over Ethernet (PoE and PoE+)
- Optional stand-alone capability supports even the most cost-sensitive Ethernet enabled designs
- Low alpha mold compound enables 80 SER FIT (VSC8541XMV-03 only)
- Devices support operating temperatures of -40 °C ambient to 125 °C junction or 0 °C ambient to 125 °C junction
- Available in 8 mm x 8 mm, 68-pin single-row QFN package

Related Products

Visit www.microsemi.com for information about these related products:

- VSC8531/VSC8531-03: Single Port Gigabit Ethernet Copper PHY with RGMII/RMII Interface
- VSC8540-03: Single Port Industrial Grade Fast Ethernet Copper PHY with Synchronous Ethernet, GMII/RGMII/MII/RMII Interface
- VSC8530-03: Single Port Industrial Grade Fast Ethernet Copper PHY with RGMII/RMII Interface



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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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